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Preferred Device

General Purpose Transistor

PNP Silicon



ON Semiconductor™

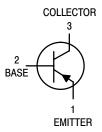
http://onsemi.com

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|----------------|----------------|
| Collector-Emitter Voltage | V _{CEO} | -60 | Vdc |
| Collector-Base Voltage | V _{CBO} | -60 | Vdc |
| Emitter-Base Voltage | V _{EBO} | -5.0 | Vdc |
| Collector Current – Continuous | I _C | -600 | mAdc |
| Total Device Dissipation @ T _A = 25°C Derate above 25°C | P _D | 625 5.0 | mW mW/°C |
| Total Device Dissipation @ T _C = 25°C Derate above 25°C | P _D | 1.5 12 | Watts mW/°C |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | –55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------|------|------|
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}$ | 200 | °C/W |
| Thermal Resistance, Junction to Case | $R_{	heta JC}$ | 83.3 | °C/W |





TO-92 CASE 29 STYLE 1

MARKING DIAGRAM



PN2907A = Device Code Y = Year WW = Work Week

ORDERING INFORMATION

| Device | Package | Shipping |
|-------------|---------|------------------|
| PN2907A | TO-92 | 5000 Units/Box |
| PN2907ARLRA | TO-92 | 2000/Tape & Reel |

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Chara | Symbol | Min | Max | Unit | |
|---|---|----------------------|-------------------------------|-------------------------|------|
| OFF CHARACTERISTICS | | | | |] |
| Collector–Emitter Breakdown Voltage (No (I _C = -10 mAdc, I _B = 0) | V _{(BR)CEO} | -60 | _ | Vdc | |
| Collector–Base Breakdown Voltage (I _C = –10 μAdc, I _E = 0) | | V _{(BR)CBO} | -60 | - | Vdc |
| Emitter–Base Breakdown Voltage $(I_E = -10 \mu Adc, I_C = 0)$ | | V _{(BR)EBO} | -5.0 | - | Vdc |
| Collector Cutoff Current (V _{CE} = -30 Vdc, V _{EB(off)} = -0.5 Vdc) | | I _{CEX} | - | -50 | nAdc |
| Collector Cutoff Current $ (V_{CB} = -50 \text{ Vdc}, I_E = 0) $ $ (V_{CB} = -50 \text{ Vdc}, I_E = 0, T_A = 150^{\circ}\text{C}) $ | I _{CBO} | - - | -0.01 -10 | μAdc | |
| Base Current (V _{CE} = -30 Vdc, V _{EB(off)} = -0.5 Vdc) | | | - | -50 | nAdc |
| ON CHARACTERISTICS | | | | | |
| $ \begin{array}{lll} & DC \ Current \ Gain \\ & (I_C = -0.1 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_C = -1.0 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_C = -10 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_C = -150 \ mAdc, \ V_{CE} = -10 \ Vdc) \ (Not \ (I_C = -500 \ mAdc, \ V_{CE} = -10 \ Vdc) \ (Not \ V_{CE} = -10 \ Vdc) \end{array} $ | | h _{FE} | 75 100 100 100 50 | - - - 300 - | - |
| Collector–Emitter Saturation Voltage (Note 1.) (I _C = -150 mAdc, I _B = -15 mAdc) (I _C = -500 mAdc, I _B = -50 mAdc) | | V _{CE(sat)} | _ _ | -0.4 -1.6 | Vdc |
| Base–Emitter Saturation Voltage (Note 1.) (I _C = -150 mAdc, I _B = -15 mAdc) (I _C = -500 mAdc, I _B = -50 mAdc) | | V _{BE(sat)} | | -1.3 -2.6 | Vdc |
| SMALL-SIGNAL CHARACTERISTIC | cs | | | | |
| Current–Gain – Bandwidth Product (Notes 1. and 2.), (I _C = –50 mAdc, V _{CE} = –20 Vdc, f = 100 MHz) | | f⊤ | 200 | _ | MHz |
| Output Capacitance $(V_{CB} = -10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$ | | C _{obo} | - | 8.0 | pF |
| Input Capacitance (V _{EB} = -2.0 Vdc, I _C = 0, f = 1.0 MHz) | | C _{ibo} | - | 30 | pF |
| SWITCHING CHARACTERISTICS | | | | | |
| Turn-On Time | $(V_{CC} = -30 \text{ Vdc}, I_{C} = -150 \text{ mAdc},$ | t _{on} | - | 45 | ns |
| Delay Time | $I_{B1} = -15 \text{ mAdc}$) (Figures 1 and 5) | t _d | - | 10 | ns |
| Rise Time | | t _r | - | 40 | ns |
| Turn-Off Time | $(V_{CC} = -6.0 \text{ Vdc}, I_C = -150 \text{ mAdc},$ | t _{off} | - | 100 | ns |
| Storage Time | $I_{B1} = I_{B2} = 15 \text{ mAdc}$ (Figure 2) | ts | - | 80 | ns |
| Fall Time | | t _f | _ | 30 | ns |

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 f_T is defined as the frequency at which |h_{fe}| extrapolates to unity.

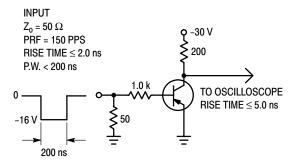


Figure 1. Delay and Rise Time Test Circuit

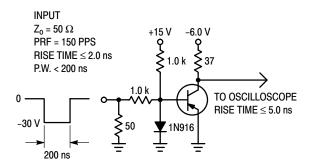


Figure 2. Storage and Fall Time Test Circuit

TYPICAL CHARACTERISTICS

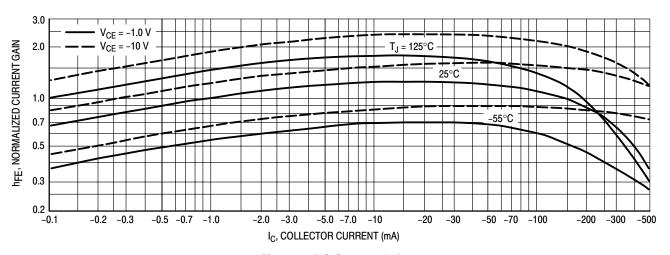


Figure 3. DC Current Gain

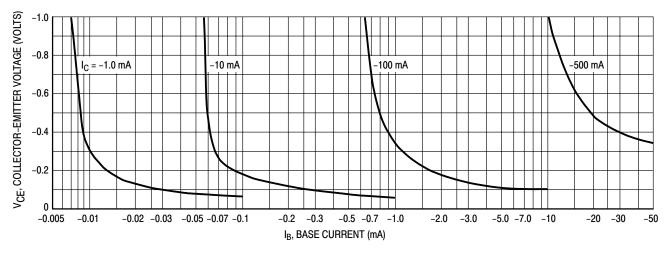


Figure 4. Collector Saturation Region

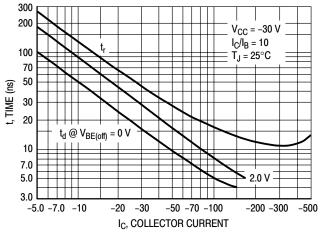


Figure 5. Turn-On Time

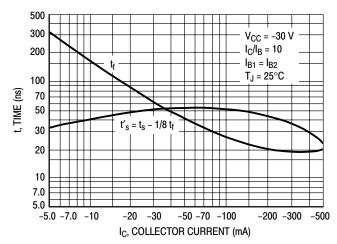
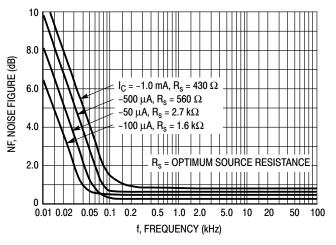


Figure 6. Turn-Off Time

TYPICAL SMALL-SIGNAL CHARACTERISTICS

NOISE FIGURE

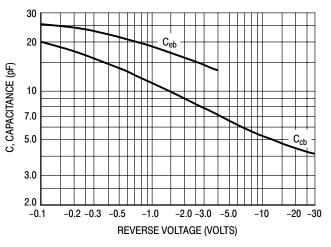
 $V_{CE} = 10 \text{ Vdc}, T_A = 25^{\circ}\text{C}$



8.0 NF, NOISE FIGURE (dB) 6.0 $I_C = -50 \mu A$ 100 μA -500 μA 4.0 -1.0 mA 2.0 50 100 200 1.0 k 2.0 k 5.0 k 10 k 20 k 50 k R_s, SOURCE RESISTANCE (OHMS)

Figure 7. Frequency Effects

Figure 8. Source Resistance Effects



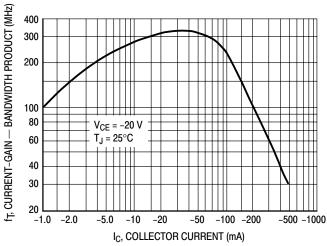
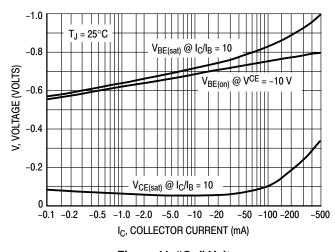


Figure 9. Capacitances

Figure 10. Current-Gain — Bandwidth Product



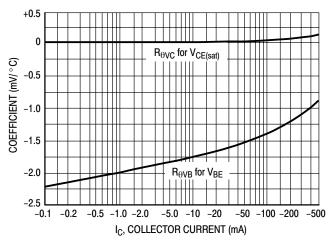


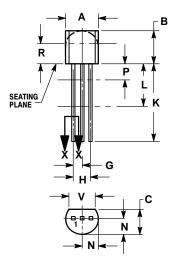
Figure 11. "On" Voltage

Figure 12. Temperature Coefficients

PACKAGE DIMENSIONS

TO-92 TO-226AA CASE 29-11

ISSUE AL





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

| | INCHES | | MILLIN | IETERS |
|-----|--------|-------|--------|--------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.175 | 0.205 | 4.45 | 5.20 |
| В | 0.170 | 0.210 | 4.32 | 5.33 |
| C | 0.125 | 0.165 | 3.18 | 4.19 |
| D | 0.016 | 0.021 | 0.407 | 0.533 |
| G | 0.045 | 0.055 | 1.15 | 1.39 |
| Н | 0.095 | 0.105 | 2.42 | 2.66 |
| J | 0.015 | 0.020 | 0.39 | 0.50 |
| K | 0.500 | | 12.70 | |
| L | 0.250 | | 6.35 | |
| N | 0.080 | 0.105 | 2.04 | 2.66 |
| P | | 0.100 | | 2.54 |
| R | 0.115 | | 2.93 | |
| V | 0 135 | | 3 43 | |

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

Notes

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